



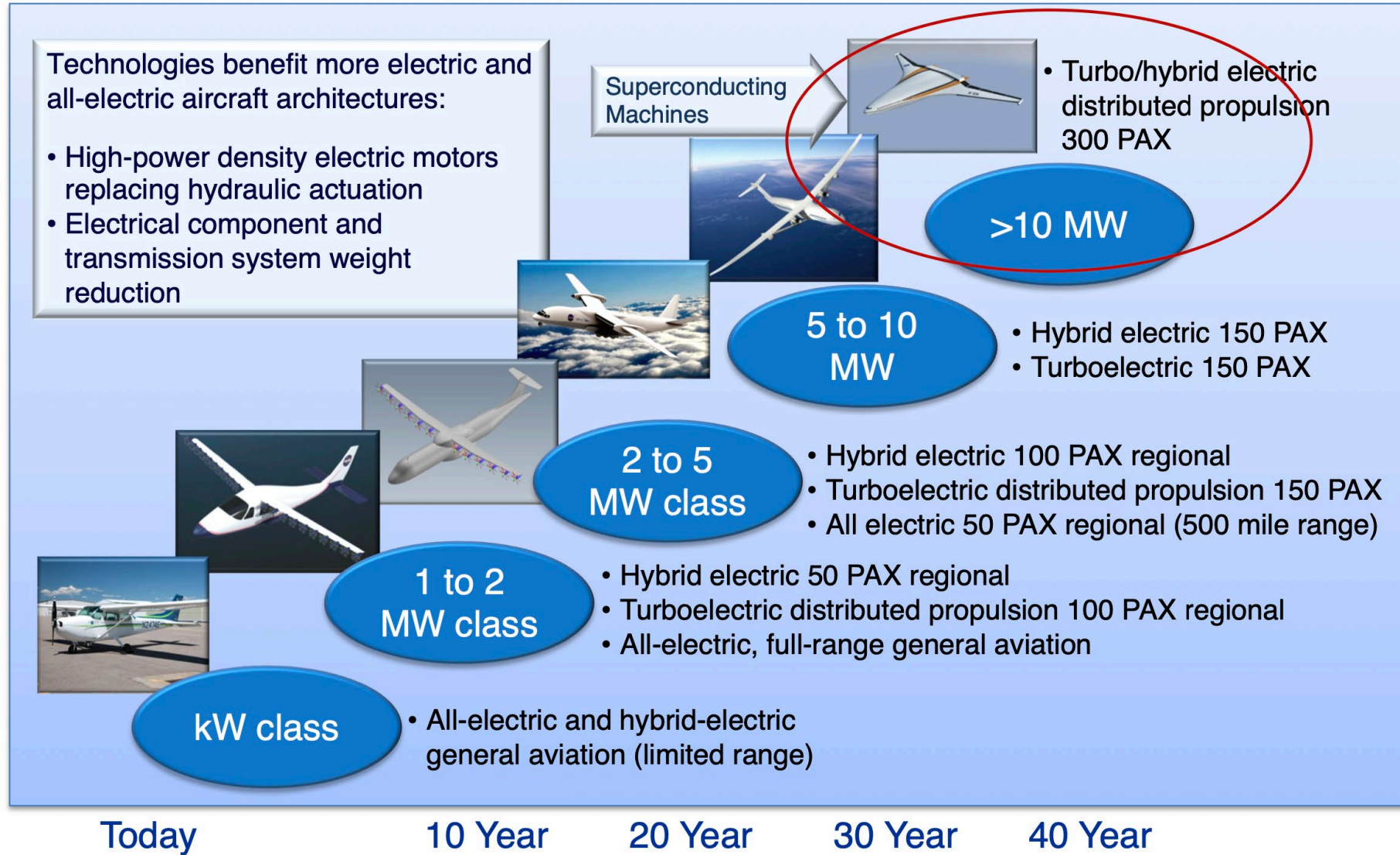
Engineered Hexagonal Boron Nitride: Titanium Dioxide Composites for High Voltage Insulation

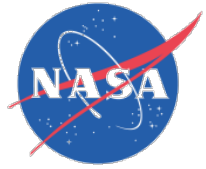
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NASA Glenn Research Center (GRC)
Universities Space Research Agency (USRA)
Cleveland, Ohio, USA

ICACC – February 1, 2024

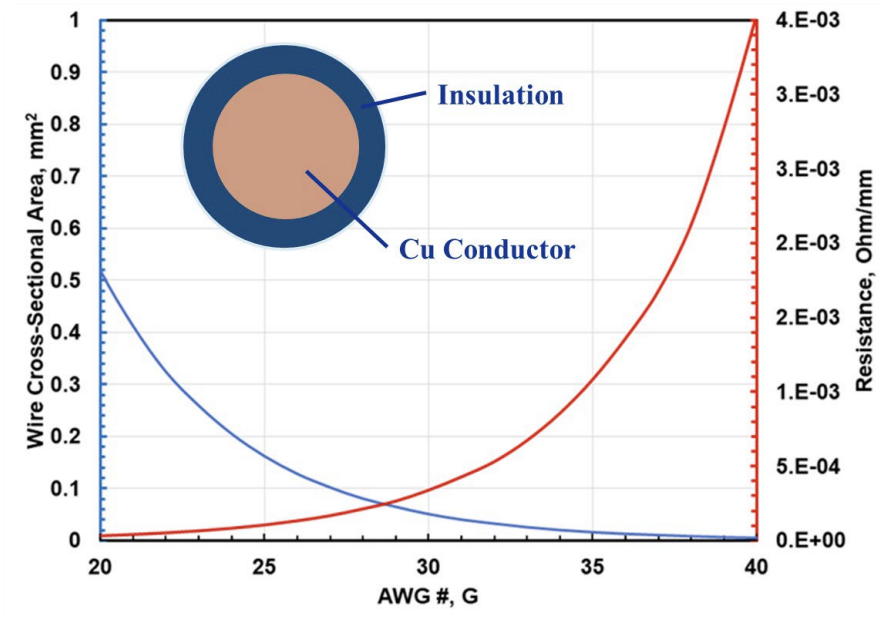
High Power Transformation of Aerospace

Power Level for Electrical Propulsion

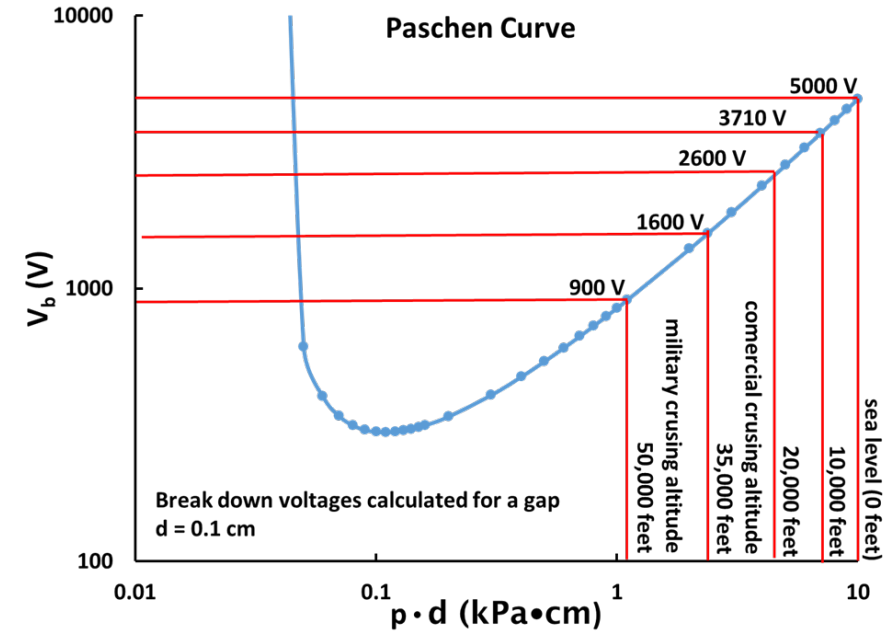




Limits of Power Transmission in Aerospace

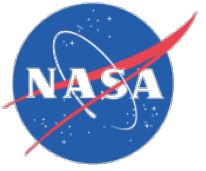


A. Amasour, D. Sacksteder, A. Goretski, M. Lizcano, NASA/TM-20205008006



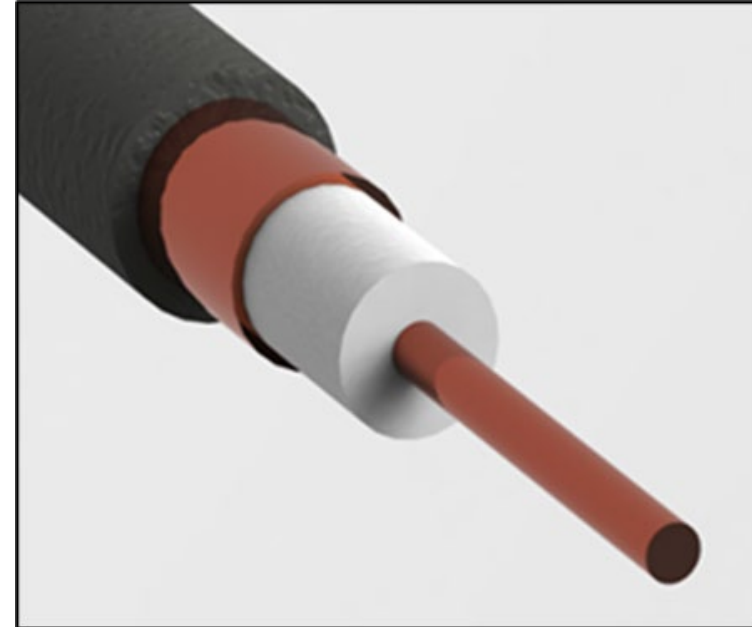
Credit: Woodworth, A.

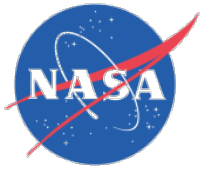
- High current requires thick and heavy copper cables, which have high resistance
- High voltage requires thick commercial insulation
- Temperature tolerance is an issue in the state-of-the-art insulation



Insulation Material Targets

- Enhanced Thermal Conductivity
- Resistance to partial discharge
- Functional Operation Temperature $> 200\text{ }^{\circ}\text{C}$
- Temperature Tolerant $> 260\text{ }^{\circ}\text{C}$
- Retains Dielectric strength of SoA materials
- Decrease diameter and weight of insulation
- Retain high strength of cable system



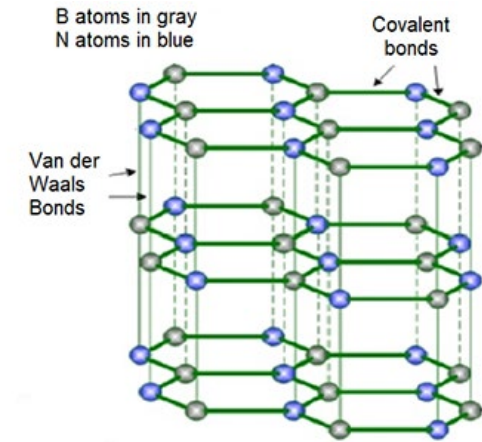


Hexagonal Boron Nitride as an Insulation Material

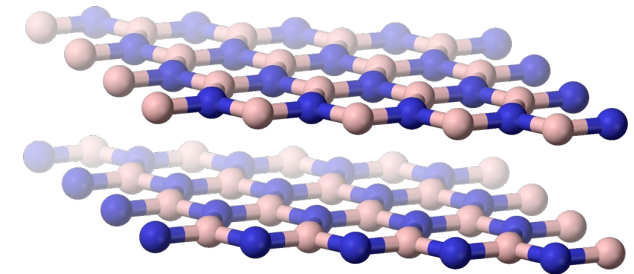
- NASA Glenn Research Center (GRC) has spent 20 years specializing in boron nitride-based research.
- Applied widely in many applications commercial and industrial.
 - Aerospace and space components
 - Radiation Shielding
 - Energy Storage
 - Lubricants
 - Thermoelectrics
 - Cosmetics
 - Paints
 - Insulation materials
 - Microelectronics

Properties

- Insulation
 - Wide bandgap above 6 eV
- Mechanical Strength
 - Similar to graphite, hard and shearing.
- Thermal Conductivity
 - hBN ~ 100 W/m·K in plane, ~ 10 - 30 W/m·K through plane
 - Strong thermal shock characteristics
- Stability
 - Hydrophobic
 - Chemically stable
 - Stable above 1000 °C in air
- Lightweight
 - 2.1 g/cm³



ACS.org



O. Shinpei, S. Fukushima, M. Shimatani,
Materials **2023**, 16(5), 2005

Engineered Hexagonal Boron Nitride

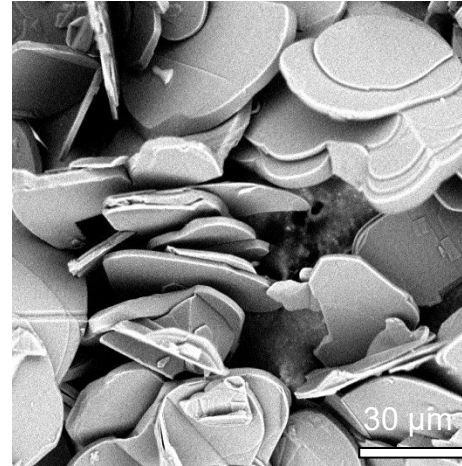
Material Control

- Shape Control
 - Platelet structure, some rods and amorphous spheres
 - Control of aspect ratio/number of layers is key
 - Can be sintered and made into larger structures. (pyrolytic)
- Size Control
 - 100s nm to 100 μm wide as platelets
 - 1 atom thick to 10s of μm thick

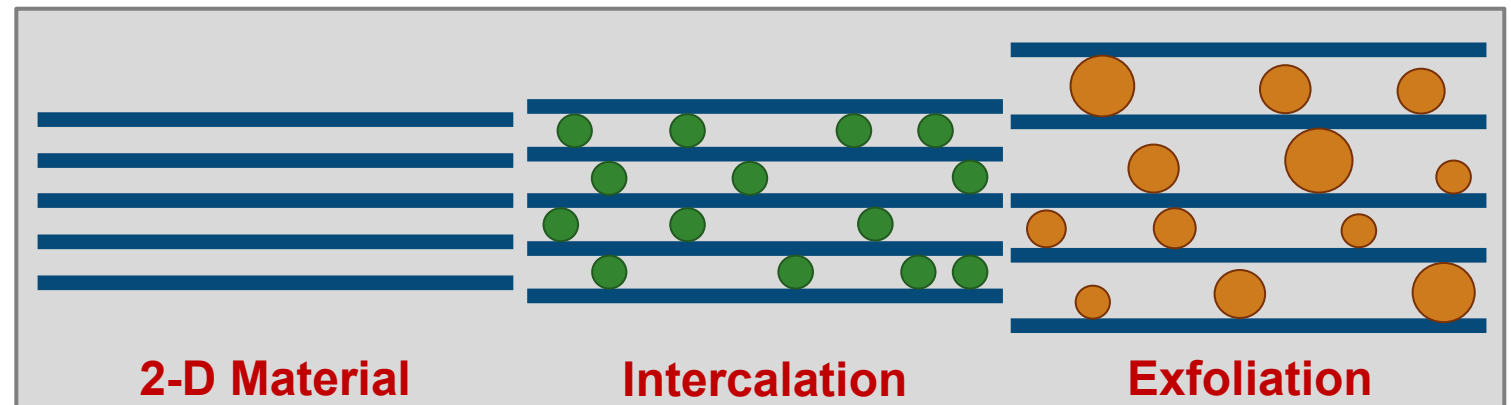
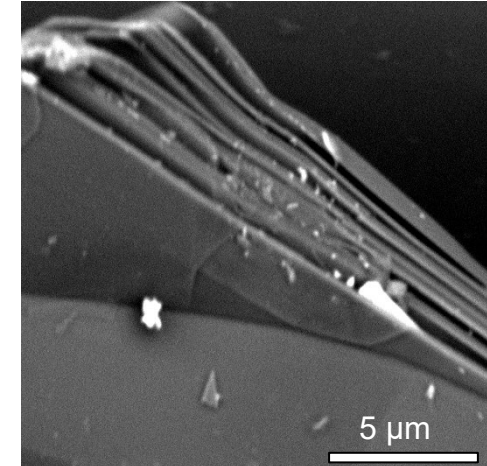
Multifunctionality

- Edge and surface functionalization
 - Oxidation, Silanation, Hydrogenation
- Intercalation
 - Metal Halides, Salts, Solvents/polymers
- Exfoliation
 - Thinner layers
 - Expanded layers

Momentive PT 110 hBN



PT 110 hBN Exfoliated with TiO_2



Three Types of Intercalation

A

Iron Oxide

- Separating Layers
- Fully removeable

B

Alumina

- Ceramic Compatibility
- Improved Thermal Shock

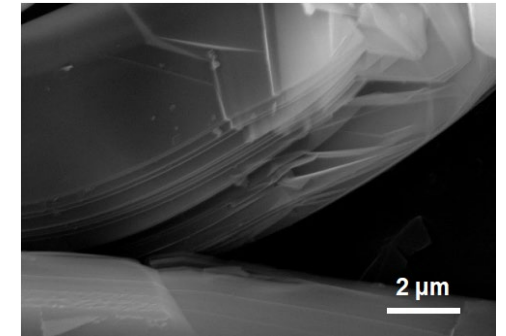
C

Titania

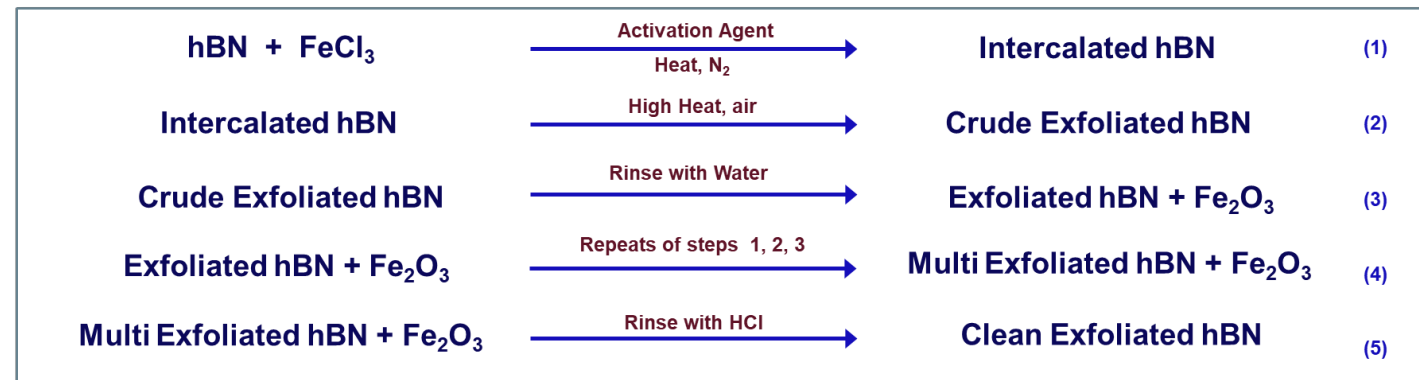
- Crystal Tunability
- Dielectric Strength
- Composite Matrix



Custom Kettle Furnace for Intercalation



Single FeCl₃ Exfoliation hBN
Credit: Nguyen, B.





Titania Properties

- Titanium Dioxide
 - Sintering temperature ~1500 C
 - Hot pressable and formable
 - Lower Thermal Conductivity, but close (~7-10 W/m·K)
 - Capacitive

Two major crystal forms, anatase and rutile

- Anatase
 - Lower density (3.78)
 - Lower dielectric constant ~14/110¹
 - Interesting semiconduction/ion conductivity properties, bandgap of 3.4 eV²
 - Longer e-hole pair lifetime can promote chemistry (better photocatalyst)
- Rutile
 - Denser form (4.23) higher than alumina
 - More stable form
 - Higher dielectric constant ~89/170¹, bandgap of 3.0 eV²
 - Bright white, used in paints

Preferentially makes small nanoparticles upon oxidation

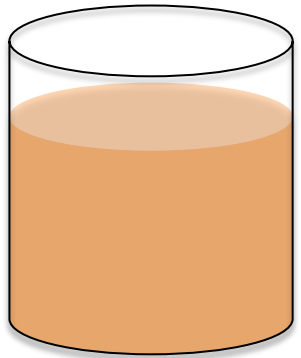
- Allows for targeted final product control

¹Matweb.com/Titanium Dioxide

²Varadwaj, P. Dinh, V, Morikawa, Y, Asahi, R. ACSOmega-**2023**-22003

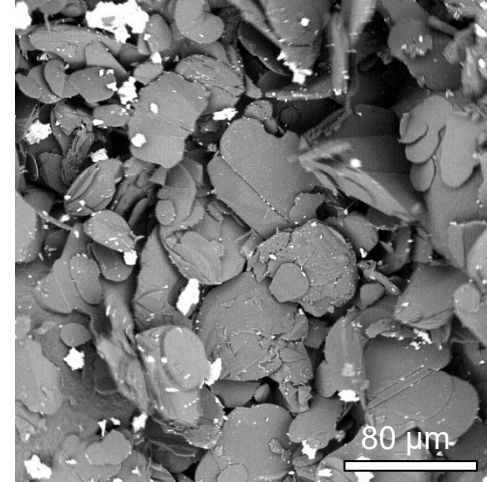
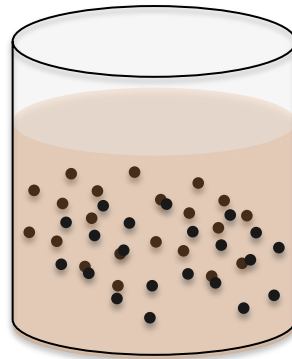
Titania Coating Method

Metal Salt
(HAuCl_3 , etc),
Surfactant



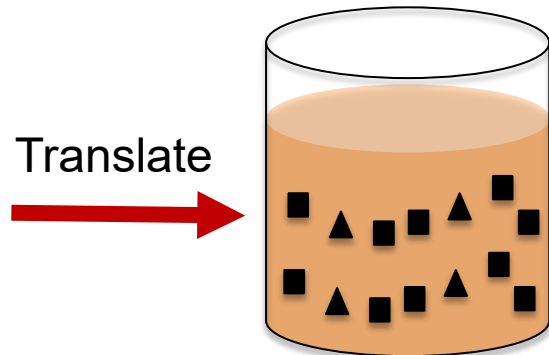
NaBH_4
Vortexing, Rapid
Injection

Seed
Nanoparticles



Sample Coated by
oxidation/metal addition

hBN, TTIP,
IPA

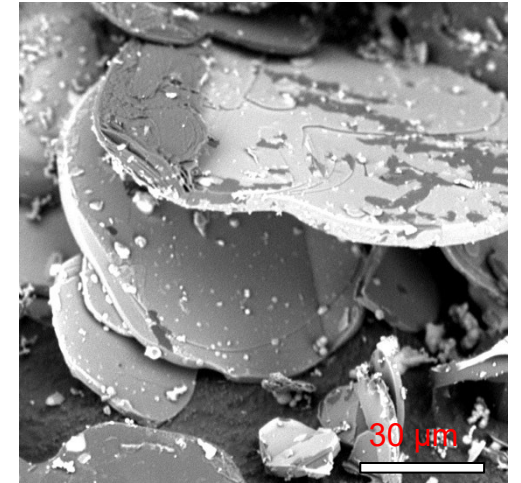
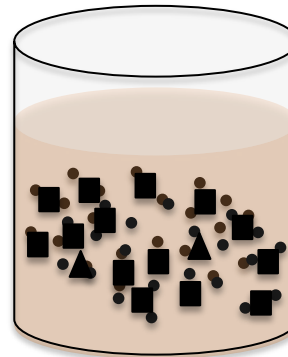


Translate



Water
Vortexing, Rapid
Injection

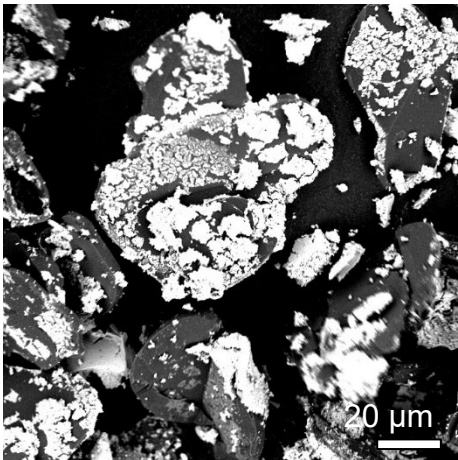
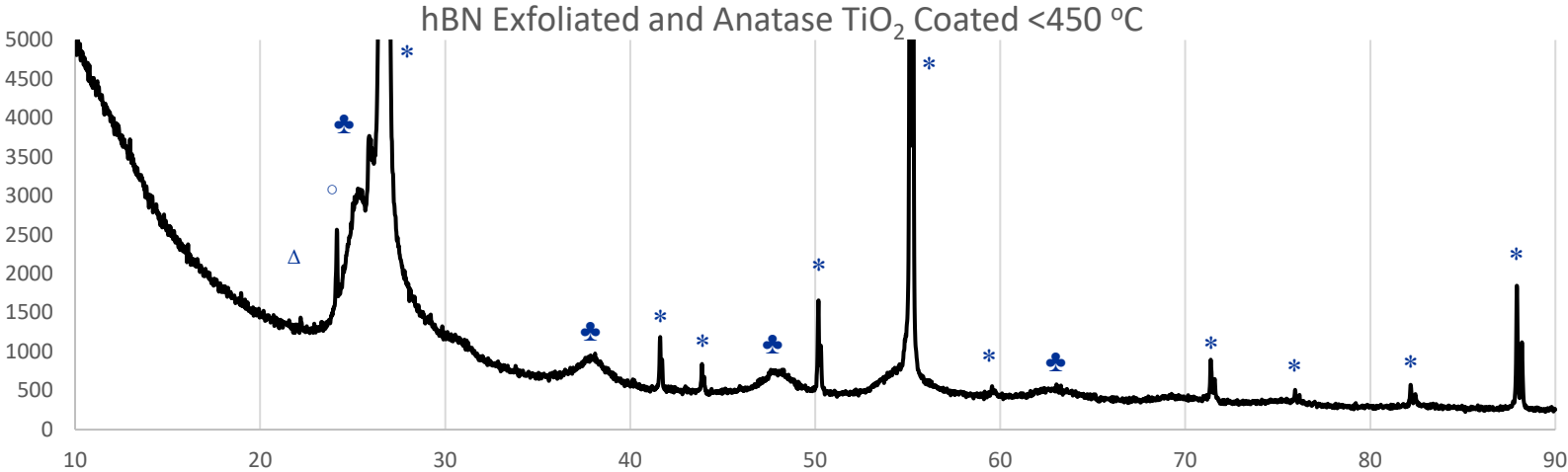
Coated hBN



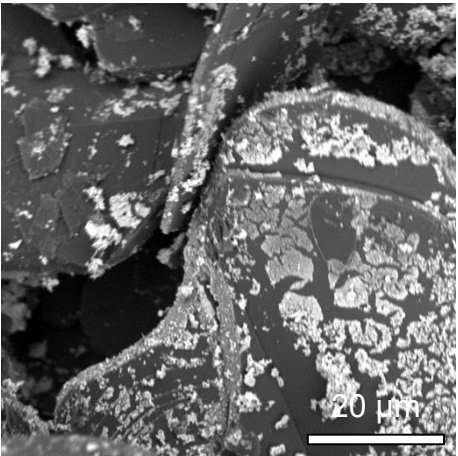
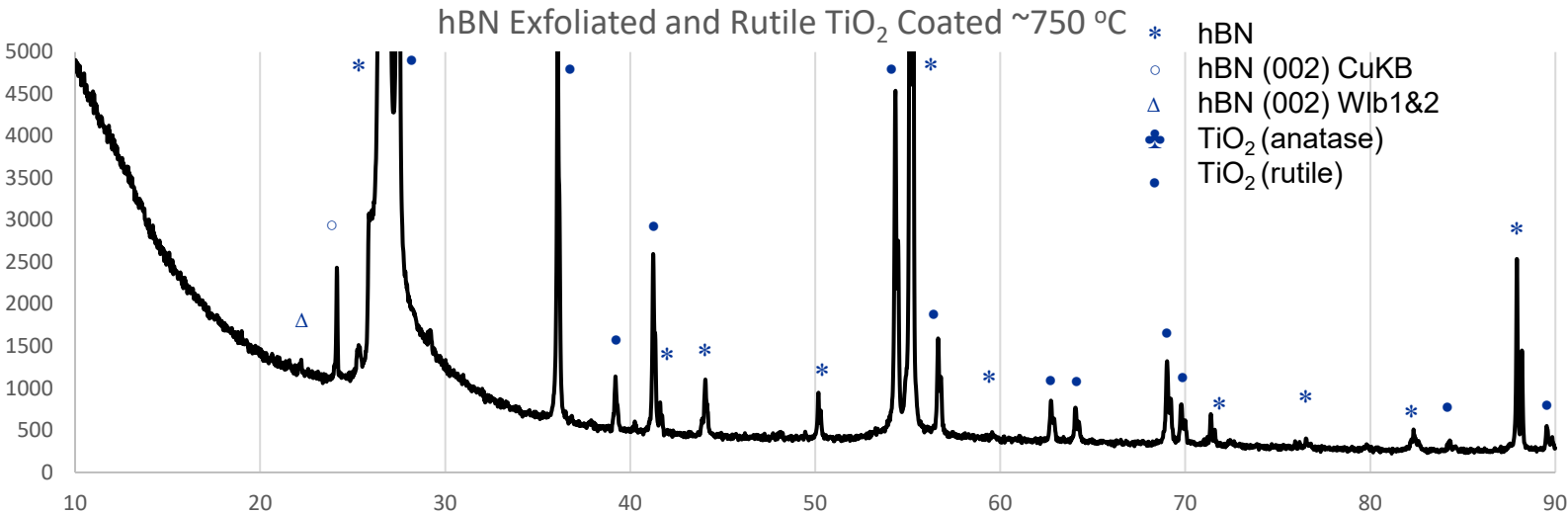
Sample Coated by diluted
TTIP/Water injection method



The Crystal Structure is Easily Tunable



hBN Coated with Anatase TiO₂

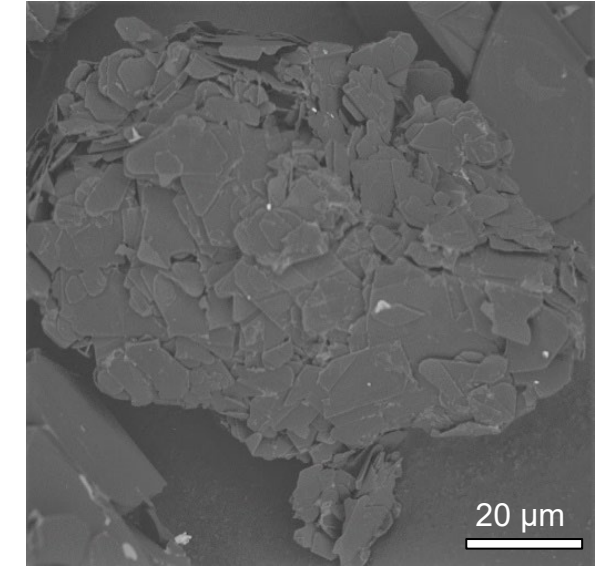
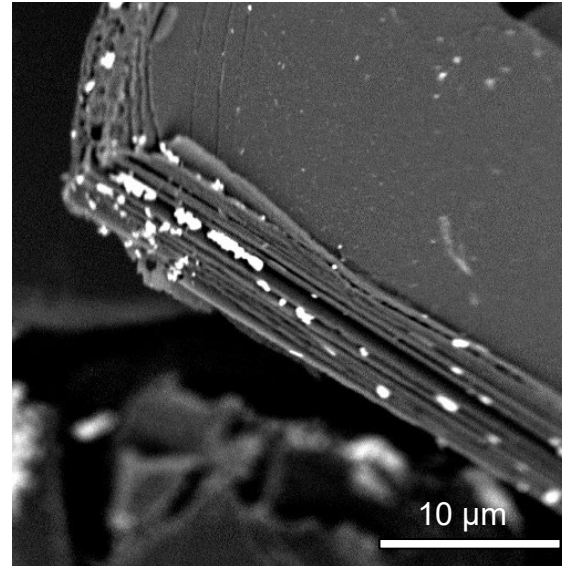


hBN Coated with Rutile TiO₂

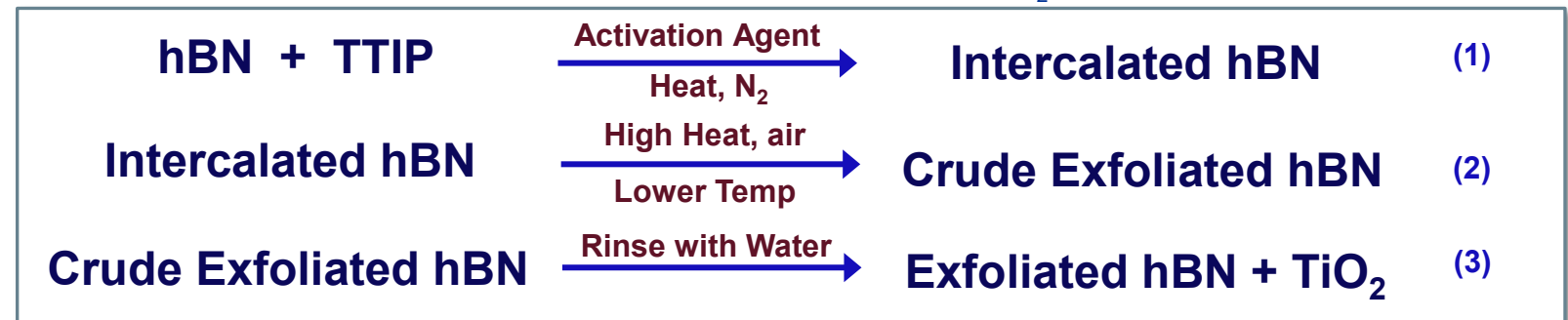
Titania Intercalation and Exfoliation

Method optimization

- TiCl_3 is hard to work with
 - Rapidly reacts with wet air
 - Low boiling point/sublimation
 - Liquid at room temperature
 - Likely to form oxide before removal or hydration
- Titanium tetraisopropoxide (TTIP)
 - Reacts slower with air
 - High boiling point (close to AlCl_3 and FeCl_3)
 - Can be diluted with isopropanol for optimal coating
 - Larger molecule
 - Liquid at room temperature



Momentive PT110 hBN (40-100 μm platelets) Intercalated and Exfoliated with TiO_2



Insulation Composite Testing

Methods of Insulation Composite Testing

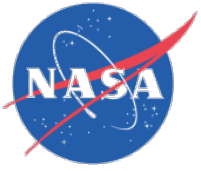
- Twin screw extrusion of target high temp polymer
 - Requires large amounts of powder composite >10 grams per run depending on loading
 - Trial and error required to achieve goal loadings
 - The best method of mixing, can make tapes and wires but hard to start with
- Small scale compounding and injection molding
 - Limited to thermoplastic polymers
 - Requires expensive equipment to use high temperature polymers
 - High throughput
- Tape Casting
 - Works at very small sample sizes
 - Can use high temp stable thermosets without expensive equipment
 - Settling of composite material may be an issue
 - High throughput

High Temp Tape Extrusion



PDMS Tape Cast with hBN





PDMS Tape Cast Composite Testing

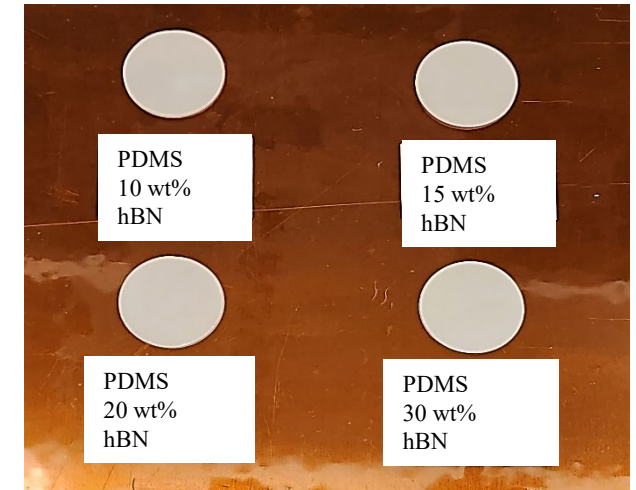
Polydimethylsiloxane (PDMS) chosen as tape cast polymer matrix

- Silgard 184 Elastomer (PDMS type)
 - Good Dielectric properties
 - Can withstand temps up to 200 C
 - Room temperature cure
 - Accelerated cure at higher temperatures
 - Low enough viscosity to mix well with composites
- Processing conditions,
 - Mix elastomer and hBN powders by shear mixing (Thinky mixer)
 - Degas
 - Pour and cast into a tape
 - Allow to cure at elevated temp over night

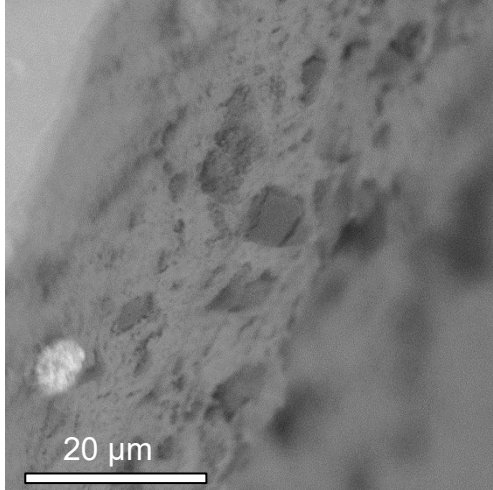
PDMS Tape Cast with hBN



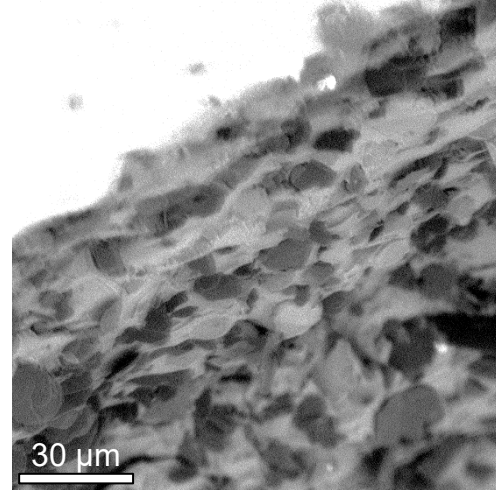
Samples Cut and Stacked for Thermal Conductivity/Breakdown



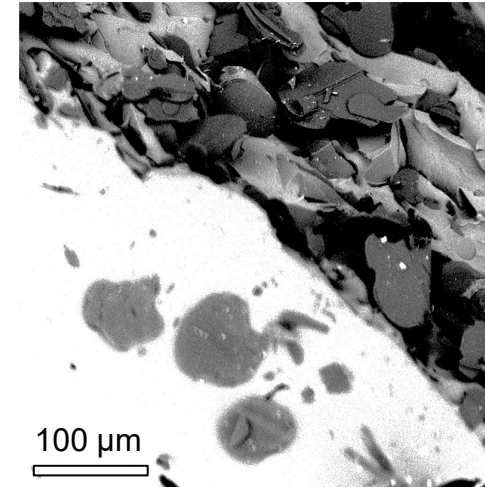
PDMS Tape Cast Composite Testing



30% AC6097 (500 nm platelets)
Small



30% PTC120 (5-10 μm platelets)
Medium

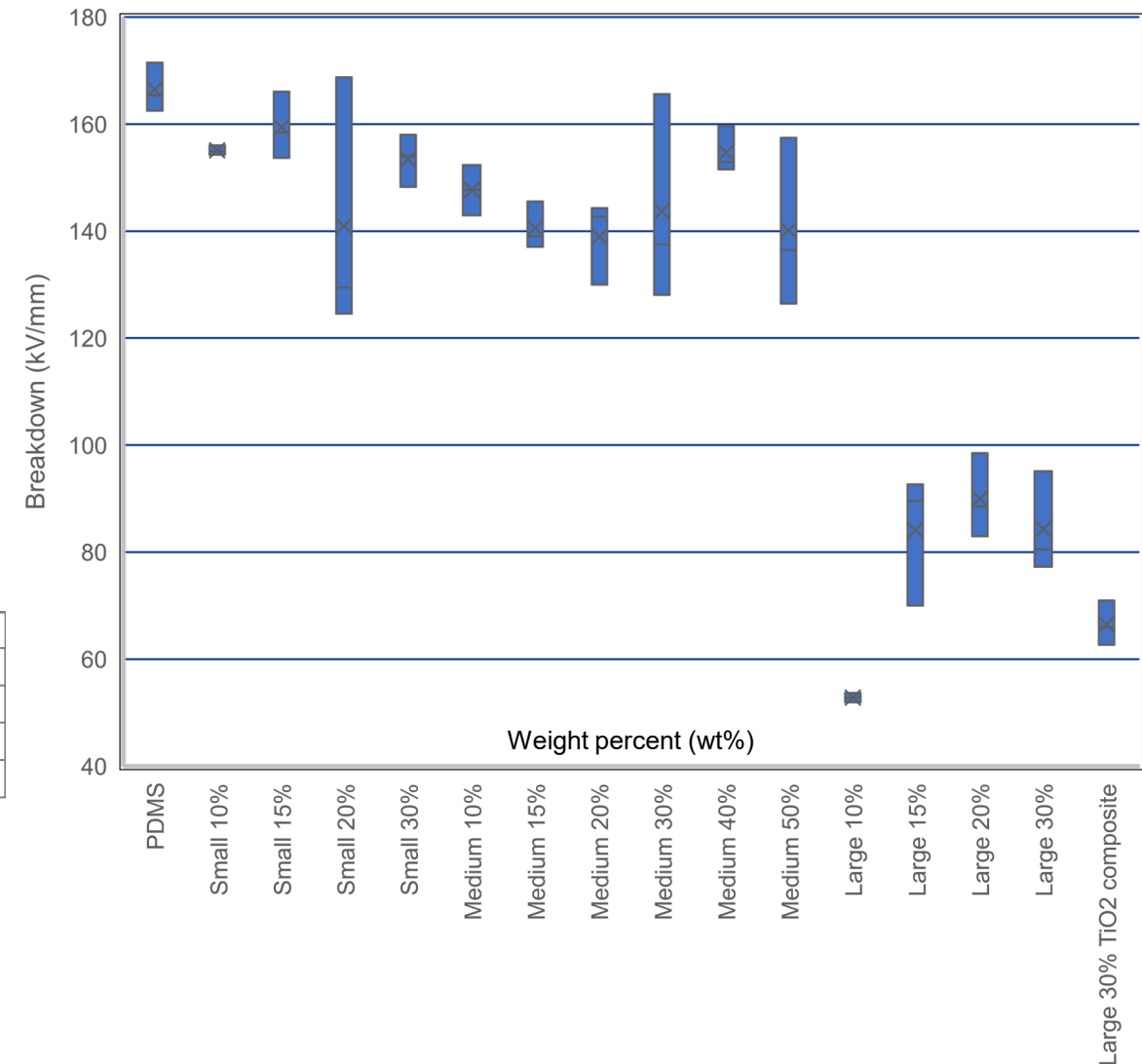
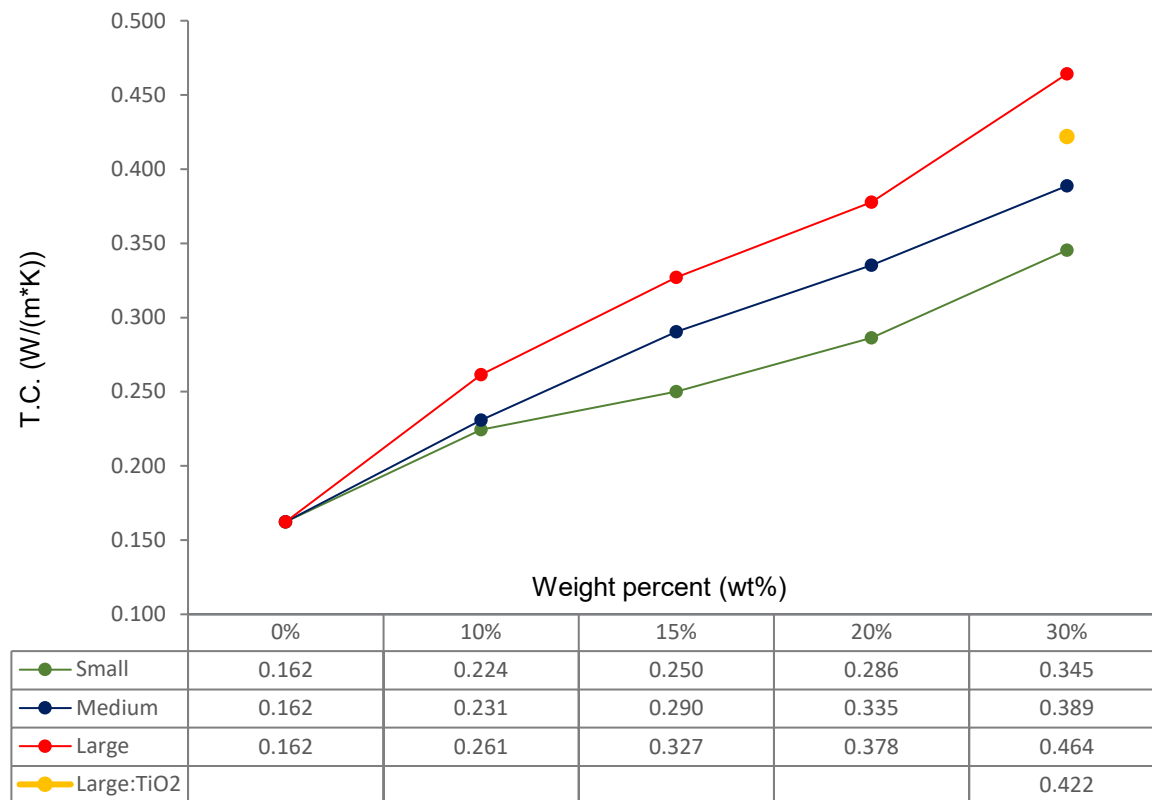


30% PT110 (40-100 μm platelets)
Large

- Cross Section Images show particle sizes inside tape
- Larger particles less well mixed and likely include air voids
- Not many particles on the surface



PDMS Tape Casting Optimization



- Thermal conductivity measured by a modified transient plane source (C-Therm, surface dissipation method)
- Breakdown done in DC 2 kV/s ramp
- Small (500 nm), Medium (5-10 μm), Large (40-100 μm)

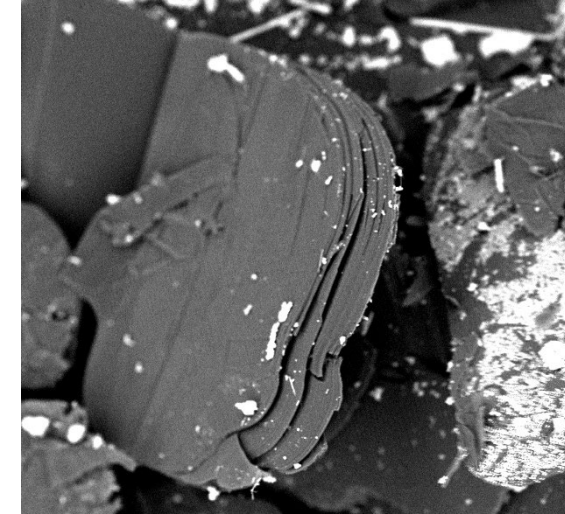
Summary of Achievements and Future Work

Accomplishments

- hBN platelets coated with titania, and both crystal patterns formed by heat treatment
- hBN exfoliated with titanium isopropoxide and separated particles formed with titanium nanoparticles interspersed
- Test platform composite properties chosen as a PDMS matrix and tested across multiple hBN types

Future Work

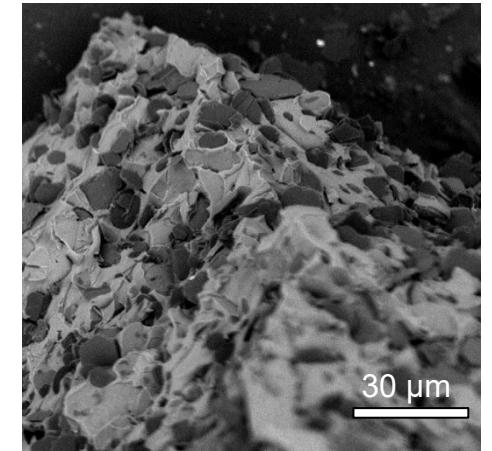
- Process improvement for large particle mixing
- Confirmation of internal structure of exfoliated hBN
- Dielectric properties testing of composites
- Multilayer stacking
- Large scale tape extrusion
- High yield exfoliation process optimization



Exfoliated PT110 with Titania



Tape extrusion from twin screw extruder



hBN/PDMS cross section



Thank You!

- Transformational Tools and Technologies (TTT) Project
- GRC Boron Nitride Team
 - Dr. Sean Patrick McDarby
 - Dr. Diana Santiago
 - Dr. Maricela Lizcano
 - Dr. Kristina Vailonis
 - Dr. Tiffany Williams
 - Dr. Baochau Nguyen
 - Dr. Witold Fuchs
 - Dr. Ching-cheh Hung (retired)
 - Ms. Alanys V, Luna
 - Ms. Janet Hurst (retired)
- Materials Chemistry and Physics Branch
- Materials and Structures Division

